VT971

FPGA High speed Digital Signal Processing utilizing Xilinx VU13P with Integrated Layer 3 Managed Switch



Key Features

- High speed DSP processing
- Xilinx Ultrascale+ VU13P FPGA
- Quad-core ARM processor at 1.4GHz per core
- Managed Layer 3 GbE/10GbE Switch
- 24xGbE + 2x40GbE Egress Ports (or any protocol such as Aurora)
 - The 40GbE could run as 8x 10GbE
- Triaxial, digital gyroscope
- Rugged conduction cooled module

Benefits

- Design utilizes proven VadaTech subcomponents and engineering techniques
- Electrical, mechanical, software, and system-level expertise in house
- Full system supply from industry leader
- AS9100 and ISO9001 certified company

Advanced MC™



VT971

The VT971 is a rugged conduction cooled module which follows the VITA specification for environmental (see ordering options). The module accepts 32 high-speed SERDES to the FPGA, which is supported by two 64-bit wide banks for DDR4 memory for the total of 16GB of memory. The FPGA is integrated with a Layer 3 Managed Gbe/10GbE Ethernet Switch, which provides 26 Egress port via front of the module. The module supports 24 GbE through RJ-45 (10/100/1000Base-T) and dual 40GbE or any protocol such as Aurora via QSFP+.

The VT971 has a quad core ARM processor utilizing four Cortex-A53 cores running at 1.4GHz. The CPU manages the layer three switch and interfaces to the FPGA via PCIe.

The VT971 is ideal for application where the signals are digitized at a remote location and processed at a different site.

The module has a Triaxial, digital gyroscope, which provides digital accelerometer, delta angle, delta velocity, angular random walk, etc.

The module comes only in conduction cool and operates with input power of 10-36V DC.



Figure 1: VT971 Front View

Chassis Layout



Figure 2: VT971 Multiple Views

Block Diagram



Figure 3: VT971 Functional Block Diagram

Specifications

Architecture				
Physical	Dimonsions	Width: 18.5"		
Fliysical	Dimensions			
		Depth: 7.5"		
_		Height: 1.5"		
Туре	Conduction Cooled	Per VITA Specification for environmental		
Configuration				
Power	VT971	90W FPGA dependent load (10-36V DC power input)		
Environmental	Temperature	See Ordering Options		
		Storage Temperature: -40° to +90°C		
	Vibration	Operating 9.8 m/s ² (1G), 5 to 500 Hz on each axis		
	Shock	Operating 325G/2 ms, 160G/1 ms		
	Relative Humidity	5 to 95% non-condensing		
Front Panel	Interface Connectors	Dual ARC6-16 high-speed serial data		
		24x RJ-45 for GbE		
		2x QSFP for 40GbE (could run any protocol such as Aurora for low latency)		
		RJ-45 for ARM Mngt port		
		2x Twinax for clock/trigger inputs and one SSMC for sine wave clock input to the PLL		
		USB for Serial and JTAG		
	Mechanical	Custom conduction cool		
Software Support	Operating System	Linux		
Other				
MTBF	MIL Hand book 217-F@ TBD hrs			
Certifications	Designed to meet FCC, CE and UL certifications, where applicable			
Standards	VadaTech is certified to both the ISO9001:2015 and AS9100D standards			
Warranty	One (1) year, see VadaTech Terms and Conditions			

INTEGRATION SERVICES AND APPLICATION-READY PLATFORMS

VadaTech has a full ecosystem of OpenVPX, ATCA and MTCA products including chassis platforms, shelf managers, AMC modules, Switch and Payload Boards, Rear Transition Modules (RTMs), Power Modules, and more. The company also offers integration services as well as preconfigured Application-Ready Platforms. Please contact VadaTech Sales for more information.

Ordering Options

VT971 – A0C-000-0HJ

A = QSFP+ TXCVRs (two)	
0 = None 1 = 40G-SR 2 = 40GBASE-LR (1KM) 3 = 40GBASE-LR (10KM) 4 = 40G-CWDM 5 = Reserved	
	H = Environmental
	See Environmental Specification
C = Clock Input for Synchronization	J = Conformal Coating
0 = AC coupled up to 250MHz (sinusoidal) 1 = DC coupled for 1PPS or low frequency	0 = No coating 1 = Humiseal 1A33 Polyurethane 2 = Humiseal 1B31 Acrylic

Environmental Specification

Conduction Cooled

		Conduction Cooled		
Option H	H = 2	H = 3	H = 4	
Operating Temperature	CC1* (0°C to +55°C)	CC3* (-40°C to +70°C)	CC4* (-40°C to +85°C)	
Storage Temperature	C1* (-40°C to +85°C)	C3* (-50°C to +100°C)	C3* (-50°C to +100°C)	
Operating Vibration	V3* (0.1 g2/Hz max)	V3* (0.1 g2/Hz max)	V3 (0.1 g2/Hz max)	
Storage Vibration	OS2* (40g)	OS2* (40g)	OS2* (40g)	
Humidity	95% non-condensing	95% non-condensing	95% non-condensing	

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Notes:

* Nomenclature per ANSI/VITA 47. Contact local sales office for conduction cooled (H = 2, 3, 4).

Related Products

VT878









- 16 ADC for synchronous capture
- Xilinx Virtex-7 XC7VX485T FPGA
- NVidia Jetson TX2 System on Module

Conduction cooled two-module chassis

Versatile Layer 2 managed Ethernet switch

• Up to eight SFP+ Ports on the front panel

• Designed for bulkhead mount in ground or air vehicle

Compact and robust design

• Total of 24 Ports of 10GbE

Contact

VadaTech Corporate Office

198 N. Gibson Road, Henderson, NV 89014 Phone: +1 702 896-3337 | Fax: +1 702 896-0332

Asia Pacific Sales Office

7 Floor, No. 2, Wenhu Street, Neihu District, Taipei 114, Taiwan Phone: +886-2-2627-7655 | Fax: +886-2-2627-7792

VadaTech European Sales Office

VadaTech House, Bulls Copse Road, Southampton, SO40 9LR Phone: +44 2380 016403

info@vadatech.com | www.vadatech.com

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